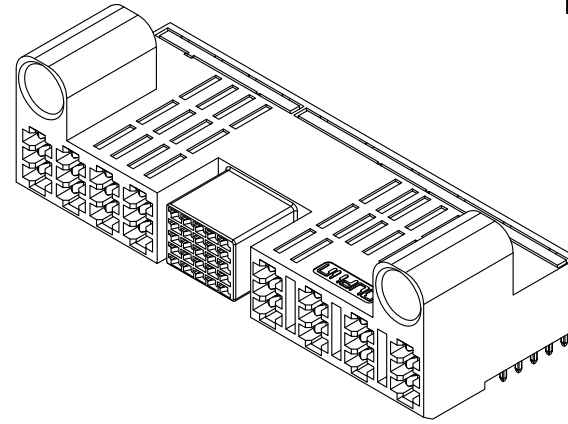
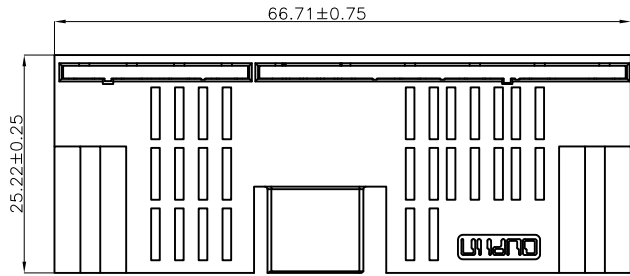


REV.	SPECIFICATION	ECN NO.	APPD.
R2		ECN170307	



**Material and Plating:**

Housing: LCP, 30% Glass Filled, UL94V-0, BLACK.  
 Power Contacts: High Conductivity Copper.  
 30u"Au+Pd/Ni on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min.  
 Signal Contact: Phosphor Bronze.  
 30u"Au+Pd/Ni on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min.

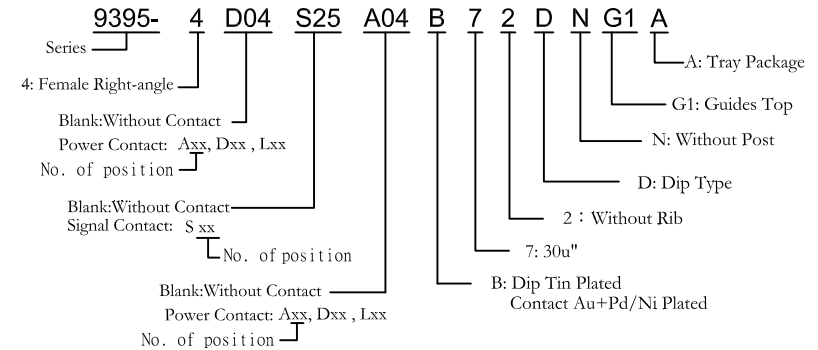
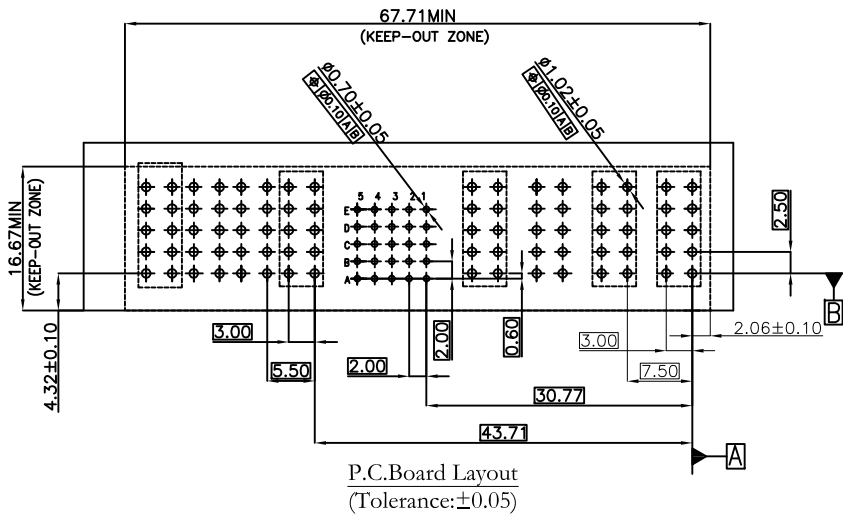
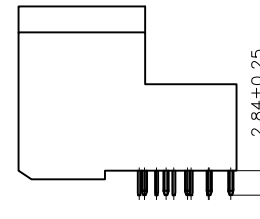
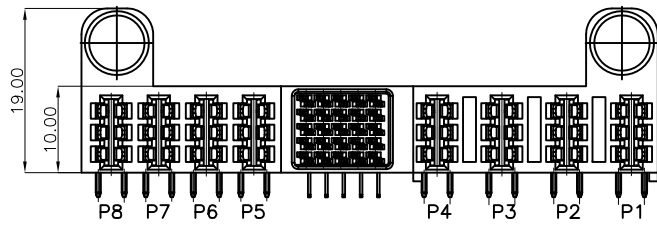
**Electrical Characteristics:**

Current Rating: Signal Pin 2.5 AMP.  
 Power Pin 60 AMP.  
 Dielectric Withstanding Voltage: DC 1500V For 1 minute.  
 Insulator Resistance: 5000MΩ min. at DC 500V.  
 Contact Resistance: Signal Pin 30mΩ max.  
 Power Pin 0.3mΩ max.  
 Operating Temperature: -40°C ~+105°C .

**\*RoHS Compliant**

Notes :

- L: Low Power---PCB Mount 3.0mm Pitch
- D: DC Power---PCB Mount 5.5mm Pitch
- A: AC Power---PCB Mount 7.5mm Pitch



Tolerances	Dwg. No.	9395-D0000-004	Title: 9395 Series		<b>OUPIN</b> OUPIN ELECTRONIC(KUNSHAN) CO., LTD. P/N: 9395-4D04S25A04B72DNG1A			
x = ±0.5	Projection		Max P60					
.x = ±0.25	Unit	mm	Scale	1:1	SHEET	1/1	Ver. No.	R2
.xx = ±0.15	Drawn By	WP 03/03'17	10mm Low Profile, 60Amp Receptable, Right Angle					